

**Features**

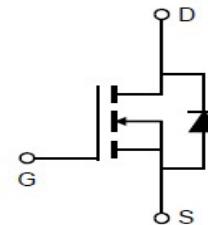
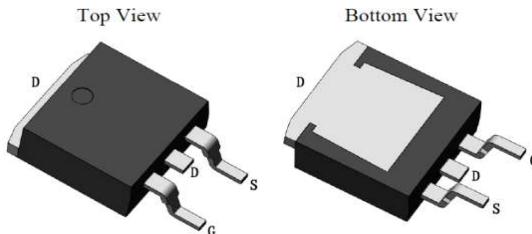
- CRM(CQ) Super\_Junction technology
- Much lower Ron\*A performance for On-state efficiency
- Better efficiency due to very low FOM
- Ultra-fast body diode
- Qualified for industrial grade applications according to JEDEC

**Product Summary**

V <sub>DS,min</sub>	650V
R <sub>DS(on),typ</sub>	90mΩ
I <sub>D</sub>	32A

**Applications**

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Charger
- Power Supply

**100% DVDS Tested****100% Avalanche Tested****Package Marking and Ordering Information**

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRJS99N65G2BF	CRJS99N65G2BF	TO-263	Tape&Reel	N/A	N/A	1000pcs

**Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Drain-source voltage	V <sub>DS</sub>	650	V
Continuous drain current <sup>1)</sup> T <sub>C</sub> = 25°C T <sub>C</sub> = 100°C	I <sub>D</sub>	32 20	A
Pulsed drain current <sup>2)</sup> (T <sub>C</sub> = 25°C, t <sub>p</sub> limited by T <sub>j,max</sub> )	I <sub>D,pulse</sub>	96	A
Avalanche energy, single pulse (L=30mH)	E <sub>AS</sub>	480	mJ
MOSFET dv/dt ruggedness	dv/dt	50	V/ns
Gate-Source voltage	V <sub>GS</sub>	±30	V
Power dissipation (T <sub>C</sub> = 25°C)	P <sub>tot</sub>	271	W
Continuous diode forward current(T <sub>C</sub> = 25°C)	I <sub>S</sub>	32	A
Diode pulse current <sup>2)</sup> (T <sub>C</sub> = 25°C)	I <sub>S,pulse</sub>	96	A
Recovery diode dv/dt <sup>3)</sup>	dv/dt	50	V/ns
Maximum diode commutation speed	di <sub>F</sub> /dt	800	A/μs
Operating junction and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55...+150	°C

1) Limited by T<sub>j,max</sub>. Maximum Duty Cycle D = 0.502) Pulse width t<sub>p</sub> limited by T<sub>j,max</sub>3) Identical low side and high side switch with identical R<sub>g</sub>



华润微电子(重庆)有限公司

CRJS99N65G2BF

SJMOS N-MOSFET 650V, 90mΩ, 32A

**Thermal Resistance**

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Thermal resistance, junction – case	R <sub>thJC</sub>	-	0.33	0.46	°C/W	
Thermal resistance, junction – ambient	R <sub>thJA</sub>	-	-	99	°C/W	

**Electrical Characteristic (at T<sub>j</sub> = 25 °C, unless otherwise specified)**

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

**Static Characteristic**

Drain-source breakdown voltage	BV <sub>DSS</sub>	650	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA
Gate threshold voltage	V <sub>GS(th)</sub>	3.2	-	4.6	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	-	5	μA	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V T <sub>j</sub> =25°C T <sub>j</sub> =150°C
Gate-source leakage current	I <sub>GSS</sub>	-	-	±100	nA	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	90	103	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =17A, T <sub>j</sub> =25°C T <sub>j</sub> =150°C
Transconductance	g <sub>fs</sub>	-	19	-	S	V <sub>DS</sub> =20V, I <sub>D</sub> =17A

**Dynamic Characteristic**

Input Capacitance	C <sub>iss</sub>	-	1900	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =100V, f=1MHz
Output Capacitance	C <sub>oss</sub>	-	117	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	-	2.2	-		
Gate Total Charge	Q <sub>g</sub>	-	70	-	nC	V <sub>GS</sub> =10V, V <sub>DS</sub> =480V, I <sub>D</sub> =17A
Gate-Source charge	Q <sub>gs</sub>	-	17	-		
Gate-Drain charge	Q <sub>gd</sub>	-	45	-		
Gate plateau voltage	V <sub>plateau</sub>	-	7.7	-		
Turn-on delay time	t <sub>d(on)</sub>	-	50	-		
Rise time	t <sub>r</sub>	-	100	-	ns	V <sub>GS</sub> =10V, I <sub>D</sub> =17A, V <sub>DS</sub> =400V, R <sub>g</sub> =27Ω
Turn-off delay time	t <sub>d(off)</sub>	-	180	-		
Fall time	t <sub>f</sub>	-	50	-		
Gate resistance	R <sub>g,int</sub>	-	0.9	-	Ω	f=1MHz



华润微电子(重庆)有限公司

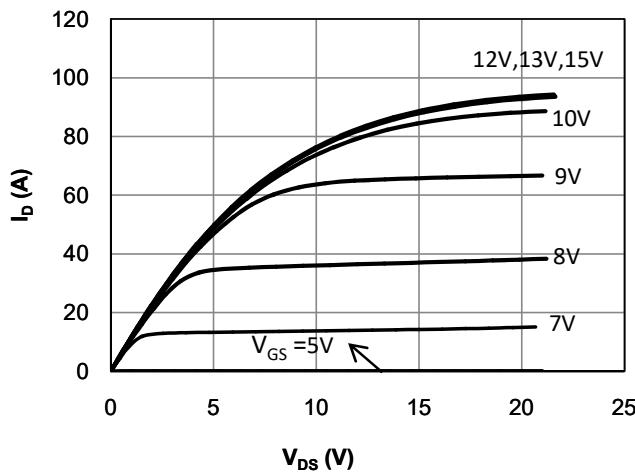
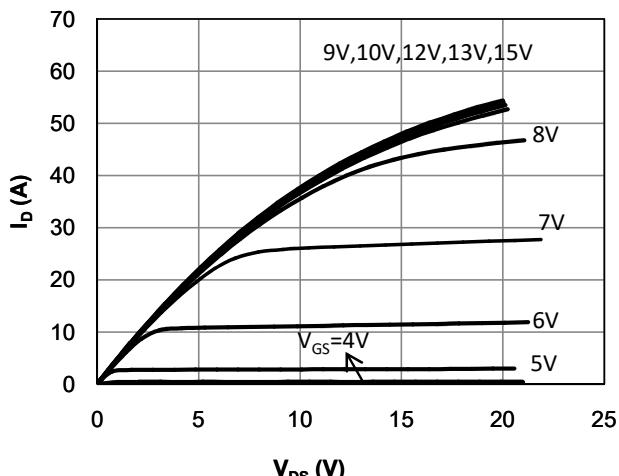
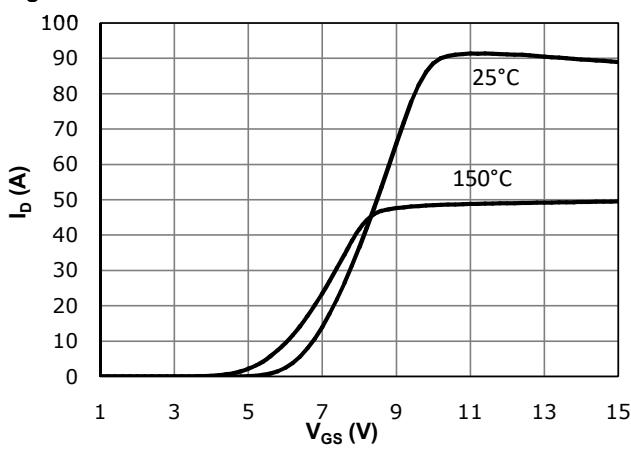
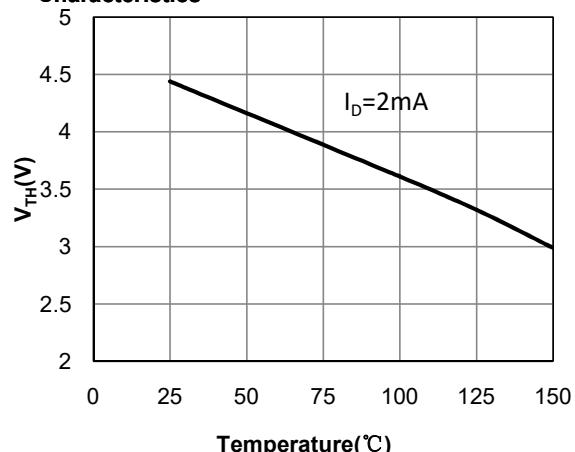
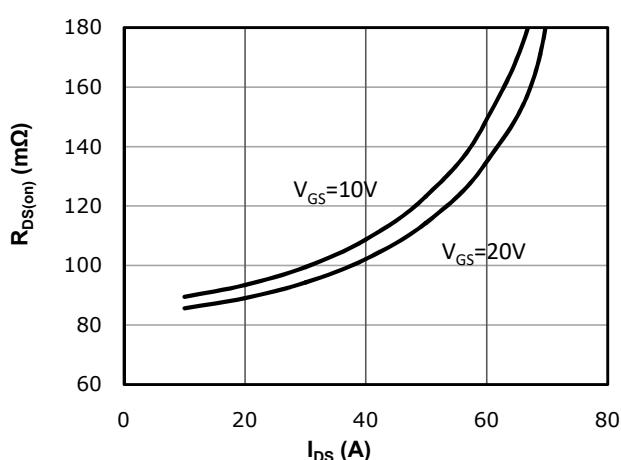
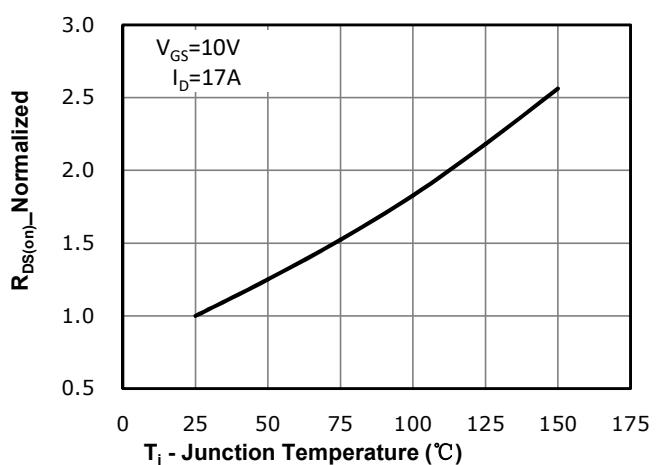
CRJS99N65G2BF

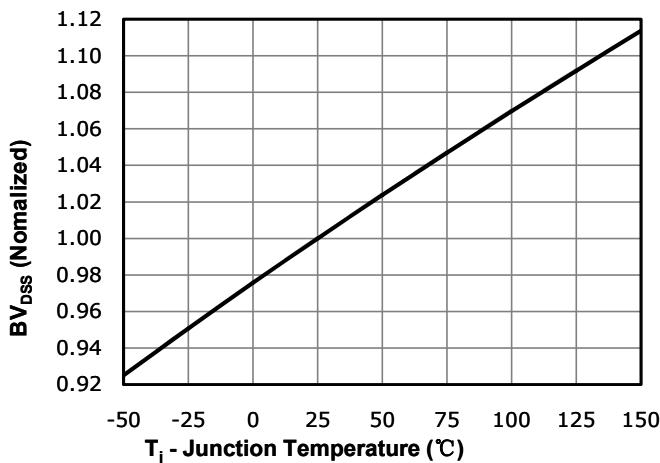
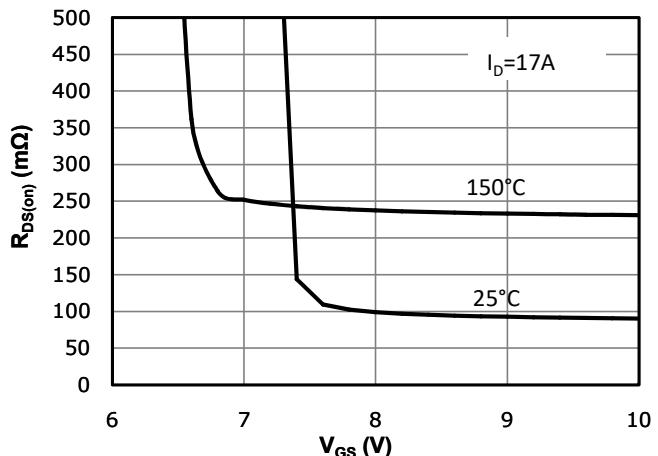
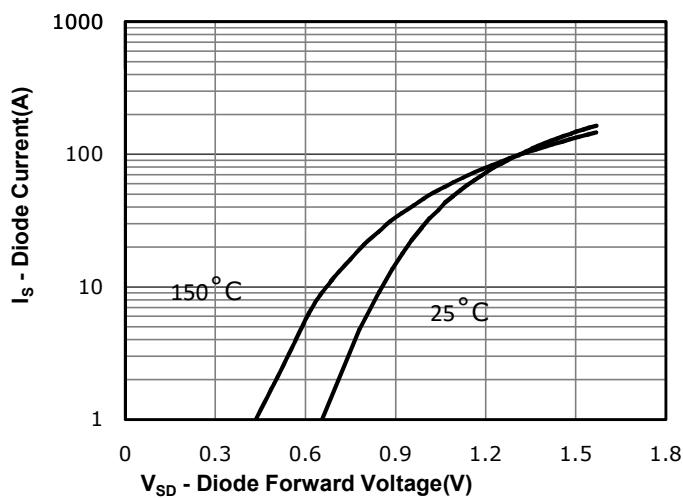
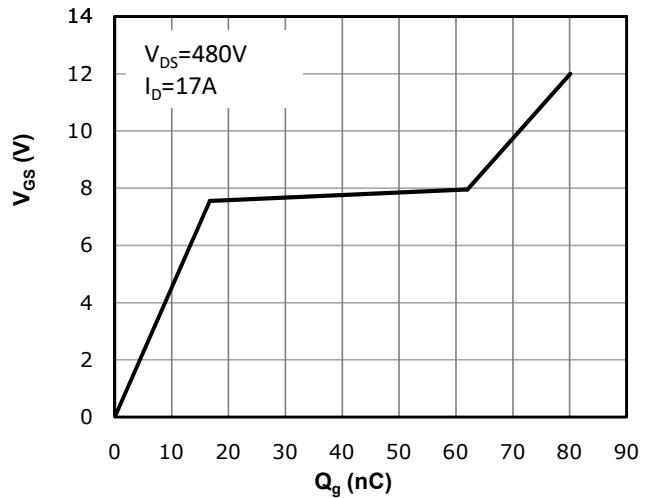
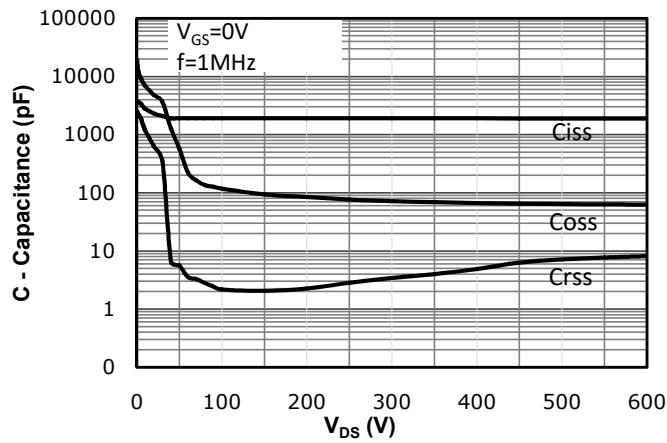
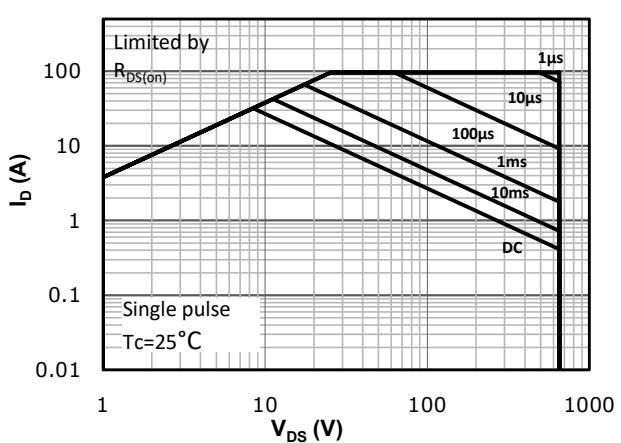
SJMOS N-MOSFET 650V, 90mΩ, 32A

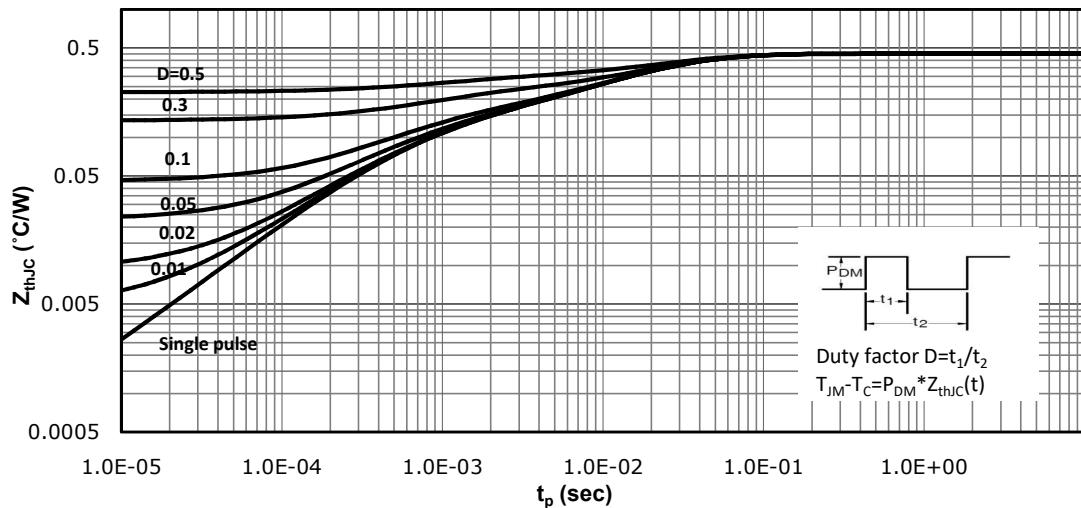
### Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	$V_{SD}$	0.7	0.9	1.1	V	$V_{GS}=0V, I_{SD}=17A$
Body Diode Reverse Recovery Time	$t_{rr}$	-	140	-	ns	$I_{SD}=17A$ $di_F/dt=100A/\mu s$
Body Diode Reverse Recovery Charge	$Q_{rr}$	-	0.89	-	$\mu C$	$V_{DS}=400V$

## Typical Performance Characteristics

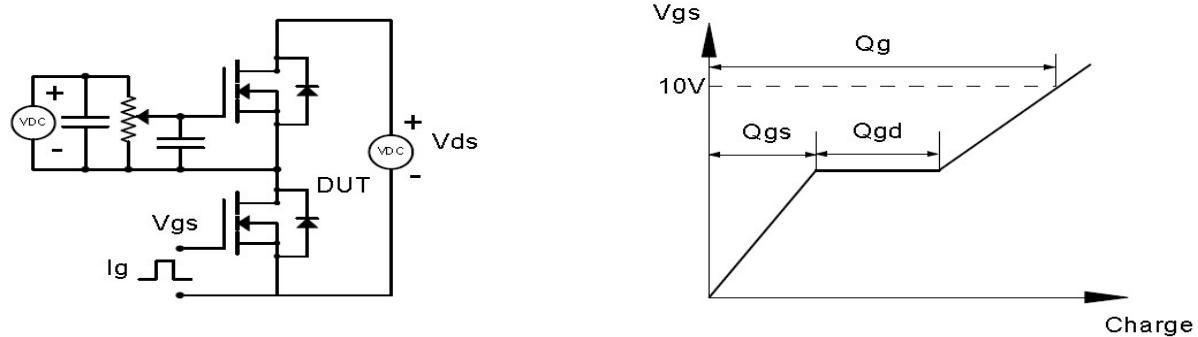
**Fig 1. Output Characteristics ( $T_j=25^\circ\text{C}$ )**

**Fig 2. Output Characteristics ( $T_j=150^\circ\text{C}$ )**

**Fig 3: Transfer Characteristics**

**Fig 4:  $V_{TH}$  Vs.  $T_j$  Temperature Characteristics**

**Fig 5:  $R_{DS(on)}$  vs.  $I_{DS}$  Characteristics ( $T_j=25^\circ\text{C}$ )**

**Fig 6:  $R_{DS(on)}$  vs. Temperature**


**Fig 7: BV<sub>DSS</sub> vs. Temperature**

**Fig 8: R<sub>DS(on)</sub> vs. Gate Voltage**

**Fig 9: Body-diode Forward Characteristics**

**Fig 10: Gate Charge Characteristics**

**Fig 11: Capacitance Characteristics**

**Fig 12: Safe Operating Area**


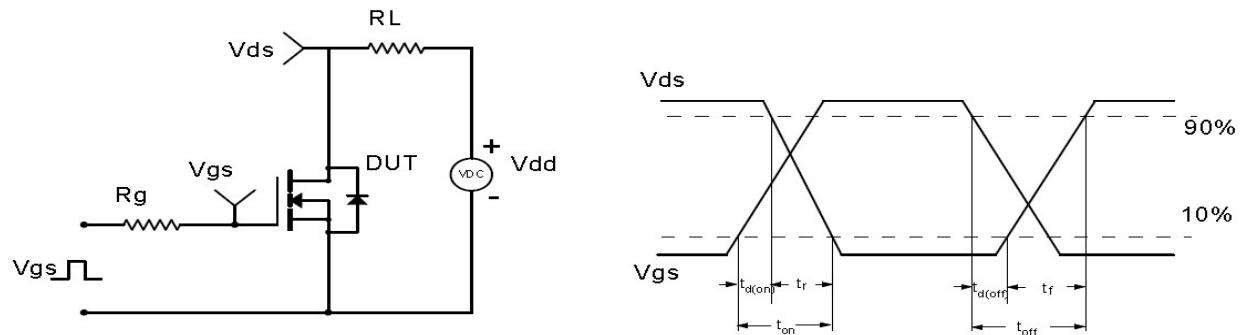
**Fig 13: Max. Transient Thermal Impedance**

**Test Circuit & Waveform**

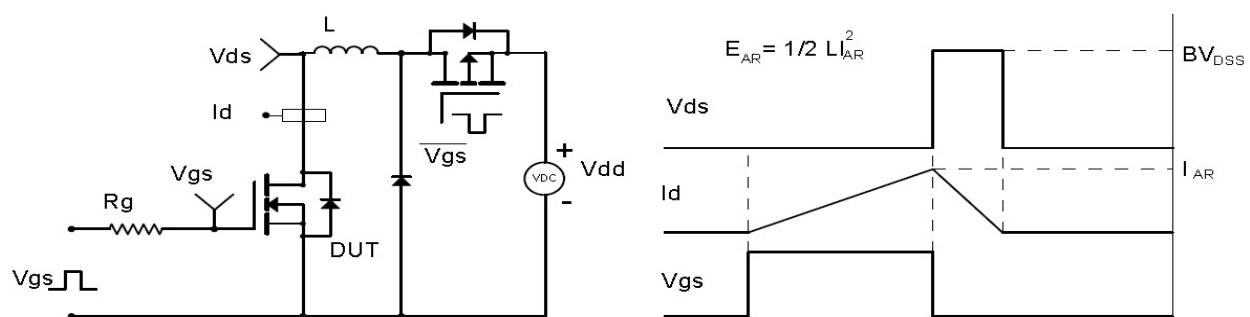
Gate Charge Test Circuit &amp; Waveform



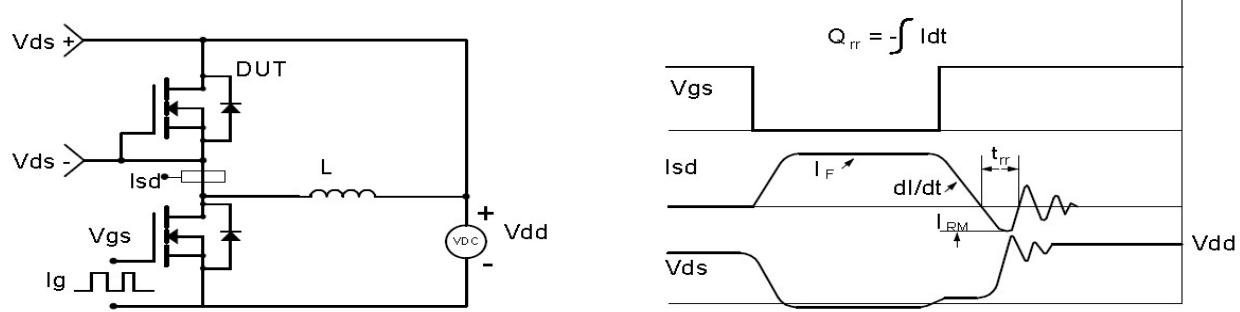
Resistive Switching Test Circuit &amp; Waveforms

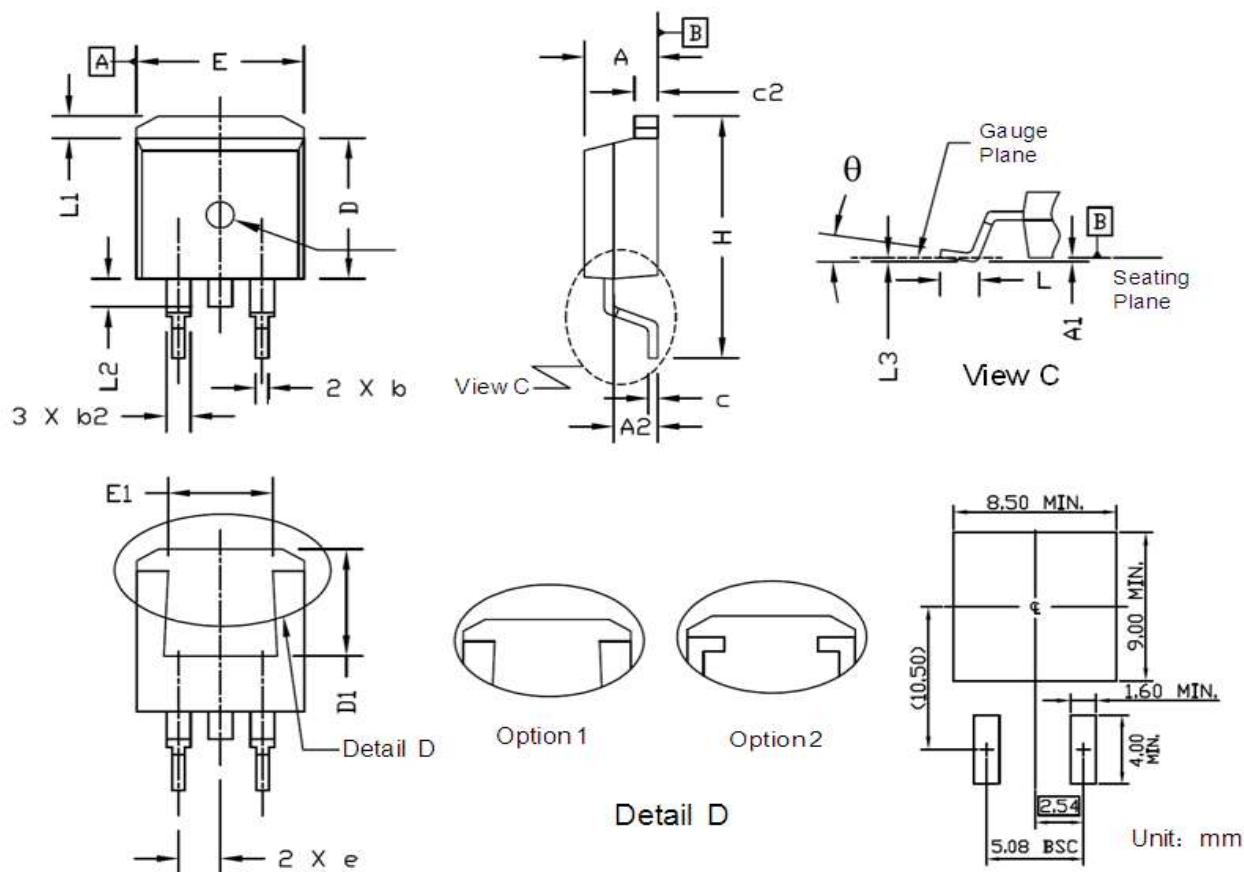


Unclamped Inductive Switching (UIS) Test Circuit &amp; Waveforms



Diode Recovery Test Circuit &amp; Waveforms



**Package Outline: TO-263**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.30	4.86	0.169	0.191
A1	0.00	0.25	0.000	0.010
A2	2.20	2.90	0.087	0.114
b	0.68	0.94	0.027	0.037
b2	1.14	1.78	0.045	0.070
c	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.38	9.45	0.330	0.372
D1	6.90	8.17	0.272	0.322
e	2.54 BSC.		0.100 BSC.	
E	9.78	10.50	0.385	0.413
E1	6.50	8.60	0.256	0.339
H	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
L3	0.25 BSC.		0.010 BSC.	
θ	Option A	-8°	0°	-8°
	Option B	0°	8°	0°



华润微电子(重庆)有限公司

CRJS99N65G2BF

SJMOS N-MOSFET 650V, 90mΩ, 32A

## Marking



### NOTE:

NXBBAAAA

N —WB code (Usually omitted)

X —Assembly location code

BB —Fab code

AAAA —Lot code



华润微电子(重庆)有限公司

CRJS99N65G2BF

SJMOS N-MOSFET 650V, 90mΩ, 32A

## Revision History

Revison	Date	Major changes
1.1	2023/6/14	Update VTH spec and marking

## Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.